Hydrogen Peroxide, 30% CMOS (Stabilized)



Material No.: 2190-03

Revision No.: 0

Product Specification

Test	Specification	
Assay (H ₂ O ₂)	30.0 - 32.0 %	
Color (APHA)	≤ 10	
Free Acid (µeq/g)	≤ 0.2	
Residue after Evaporation	≤ 10 ppm	
Ammonium (NH ₄)	≤ 3 ppm	
Chloride (CI)	≤ 0.2 ppm	
Nitrate (NO₃)	≤ 2 ppm	
Phosphate (PO ₄)	≤ 1 ppm	
Sulfate (SO ₄)	≤ 3 ppm	
Trace Impurities - Aluminum (AI)	≤ 70.0 ppb	
Arsenic and Antimony (as As)	≤ 10.0 ppb	
Trace Impurities - Barium (Ba)	≤ 20.0 ppb	
Trace Impurities - Beryllium (Be)	≤ 10.0 ppb	
Trace Impurities - Bismuth (Bi)	≤ 20.0 ppb	
Trace Impurities - Boron (B)	≤ 10.0 ppb	
Trace Impurities - Cadmium (Cd)	≤ 10.0 ppb	
Trace Impurities - Calcium (Ca)	≤ 50.0 ppb	
Trace Impurities - Chromium (Cr)	≤ 20.0 ppb	
Trace Impurities - Cobalt (Co)	≤ 10.0 ppb	
Trace Impurities - Copper (Cu)	≤ 10.0 ppb	
Trace Impurities - Gallium (Ga)	≤ 20.0 ppb	
Trace Impurities - Germanium (Ge)	≤ 10.0 ppb	
Trace Impurities - Gold (Au)	≤ 10.0 ppb	
Heavy Metals (as Pb)	≤ 500.0 ppb	
Trace Impurities - Iron (Fe)	≤ 50.0 ppb	
Trace Impurities - Lead (Pb)	≤ 10.0 ppb	
Trace Impurities - Lithium (Li)	≤ 10.0 ppb	
Trace Impurities - Magnesium (Mg)	≤ 10.0 ppb	
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Trace Impurities - Manganese (Mn)	≤ 10.0 ppb
Trace Impurities - Molybdenum (Mo)	≤ 10.0 ppb
Trace Impurities - Nickel (Ni)	≤ 10.0 ppb
Trace Impurities - Niobium (Nb)	≤ 10.0 ppb
Trace Impurities - Potassium (K)	≤ 600.0 ppb
Trace Impurities - Silicon (Si)	≤ 100.0 ppb
Trace Impurities - Silver (Ag)	≤ 10.0 ppb
Trace Impurities - Sodium (Na)	≤ 100.0 ppb
Trace Impurities - Strontium (Sr)	≤ 10.0 ppb
Trace Impurities - Tantalum (Ta)	≤ 10.0 ppb
Trace Impurities - Thallium (TI)	≤ 50.0 ppb
Trace Impurities - Tin (Sn)	190.0 - 500.0 ppb
Trace Impurities - Titanium (Ti)	≤ 10.0 ppb
Trace Impurities - Vanadium (V)	≤ 10.0 ppb
Trace Impurities - Zinc (Zn)	≤ 50 ppb
Trace Impurities - Zirconium (Zr)	≤ 10.0 ppb
Particle Count - 0.2 μm and greater	≤ 1175 par/ml
Particle Count - 0.5 µm and greater	≤ 100 par/ml

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For Microelectronic Use

Packaging Site: Paris Mfg Ctr & DC

